

# DS14C241 Single Supply TIA/EIA-232 4 x 5 Driver/Receiver

## **General Description**

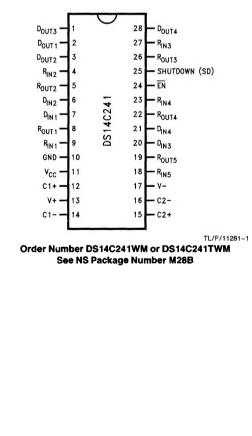
The DS14C241 is four driver, five receiver device which conforms to the TIA/EIA-232-E standard and CCITT V.28 recommendations. This device eliminates  $\pm$  12V supplies by employing an internal DC-DC converter to generate the necessary output levels from a single +5V supply. Driver slew rate control and receiver noise filtering have also been internalized to eliminate the need for external slew rate control and noise filtering capacitors. With the addition of TRI-STATE® receiver outputs and a shutdown mode, device power consumption is kept to a minimum.

The combination of its low power requirement and extended operating temperature range makes this device an ideal choice for a wide variety of commercial, industrial, and battery powered applications

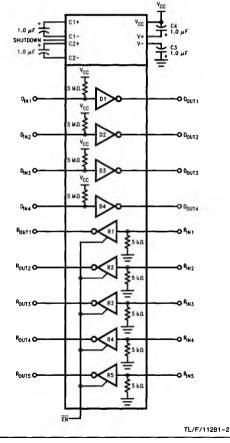
#### Features

- Conforms to TIA/EIA-232-E and CCITT V.28
- Internal DC-DC converter
- Operates with single +5V supply
- Low power requirement—I<sub>CC</sub> 10 mA max
- Shutdown mode—I<sub>CX</sub> 10 µA max
- Internal driver slew rate control
- Receiver noise filtering
- Operates above 120 kbits/sec
- TRI-STATE receiver outputs
- Direct replacement for MAX241
- Industrial temperature range option—DS14C241T (-40°C to +85°C)

### **Connection Diagram**



## **Functional Diagram**



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# Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V <sub>CC</sub> )	-0.3V to +6V
V <sup>+</sup> Pin	$(V_{CC} - 0.3V)$ to +15V
V <sup>-</sup> Pin	+0.3V to -15V
Driver Input Voltage	-0.3V to (V <sub>CC</sub> + 0.3V)
Driver Output Voltage	$(V^+ + 0.3V)$ to $(V^ 0.3V)$
Receiver Input Voltage	± 30V
Receiver Output Voltage	-0.3V to (V <sub>CC</sub> + 0.3V)
Junction Temperature	+ 150°C
Maximum Package Power D	Dissipation
@ + 25°C (Note 6)	
WM Package	1520 mW

Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 4 sec.)	+ 260°C
Short Circuit Duration (DOUT)	continuous
ESD Rating (HBM, 1.5 kΩ, 100 pF)	≥ 2.0 kV

# Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V <sub>CC</sub> )	4.5	5.5	V
Operating Free Air Temp. (TA)			
DS14C241	0	+ 70	°C
DS14C241T	-40	+85	°C

### **Electrical Characteristics**

Over recommended operating conditions, unless otherwise specified (Note 2)

Symbol	Parameter	Condition	8	Min	Тур	Max	Units
DEVICE C	HARACTERISTICS	÷					
V+	Positive Power Supply	$R_{L} = 3 k\Omega, C1-C4 = 1.0 \mu F, D$	<sub>IN</sub> = 0.8V		9.0		V
<b>v</b> -	Negative Power Supply	$R_L = 3 k\Omega, C1-C4 = 1.0 \mu F, D$	<sub>IN</sub> = 2.0V		-8.0		v
I <sub>CC</sub>	Supply Current (V <sub>CC</sub> )	No Load		0	8.5	10	mA
I <sub>CX</sub>	Supply Current Shutdown	$R_L = 3 k\Omega$ , SD = $V_{CC}$			1.0	10	μΑ
VIH	High Level Enable Voltage		SD	2.4		V <sub>CC</sub>	v
V <sub>IL</sub>	Low Level Enable Voltage			GND		0.8	v
Чн	High Level Enable Current			-10		+ 10	μΑ
կլ	Low Level Enable Current			-10		+ 10	μA
DRIVER	CHARACTERISTICS						
VIH	High Level Input Voltage		D <sub>IN</sub>	2.0		V <sub>CC</sub>	v
VIL	Low Level Input Voltage			GND		0.8	v
Чн	High Level Input Current	$V_{IN} \ge 2.0V$		-10		+ 10	μA
IIL	Low Level Input Current	V <sub>IN</sub> ≤ 0.8V		-10		+ 10	μA
V <sub>OH</sub>	High Level Output Voltage	$R_L = 3 k\Omega$		5.0	7.5		v
VOL	Low Level Output Voltage				-6.5	-5.0	V
los+	Output High Short Circuit Current	$V_{\rm O} = 0$ V, $V_{\rm IN} = 0.8$ V		-30	- 15	-5.0	mA
los-	Output Low Short Circuit Current	$V_{\rm O} = 0$ V, $V_{\rm IN} = 2.0$ V		5.0	12	30	mA
Ro	Output Resistance	$-2V \le V_0 \le +2V, V_{CC} = GNI$	D = 0V	300			Ω
RECEIVE	R CHARACTERISTICS						
VTH	Input High Threshold Voltage				1.9	2.4	v
VTL	Input Low Threshold Voltage			0.8	1.5		V
V <sub>HY</sub>	Hysteresis			0.2	0.4	1.0	v
RIN	Input Resistance			3.0	4.5	7.0	kΩ

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Symbol	Parameter		Condition	s	Mi	п Тур	Max	Units
RECEIVER	R CHARACTERISTICS (Conti	nued)		_				
IIN	Input Current	$V_{IN} = +$	15V		2.1	4 3.8	5.0	mA
		$V_{IN} = +3$	3V		0.4	3 0.6	1.0	mA
		$V_{IN} = -3$	3V		-1	0 -0.6	-0.43	mA
		$V_{IN} = -$	15V		-5	0 -3.8	-2.14	mA
VOH	High Level Output Voltage	V <sub>IN</sub> = -:	$3V, I_0 = -3.2 \text{ mA}$		3.5	4.6		v
		V <sub>IN</sub> = -:	$BV, I_O = -20 \mu A$		4.(	4.9		V
V <sub>OL</sub>	Low Level Output Voltage	V <sub>IN</sub> = +;	$3V, I_0 = +3.2 \text{ mA}$			0.25	0.4	v
VIH	High Level Input Voltage			EN	2.0		Vcc	V
VIL	Low Level Input Voltage			}	GN	D	0.8	V
Ін	High Level Input Current	V <sub>IN</sub> ≥ 2.0	v	]	- 1	0	+ 10	μA
۱ <sub>IL</sub>	Low Level Input Current	V <sub>IN</sub> ≤ 0.8	V		-1	0	+ 10	μA
loz	Output Leakage Current	EN = V <sub>C</sub>	$c, 0V \leq R_{OUT} \leq V_{CC}$		-1	0	+ 10	μΑ
	ching Characteris commended operating condit Parameter			Note 4)				
			Condi	tions	Min	TVD	Max	Units
	HARACTERISTICS		Condi	tions	Min	Тур	Max	Units
	HARACTERISTICS Propagation Delay LOW	to HIGH		lions	Min	<b>Тур</b> 0.7	<b>Max</b>	<b>Units</b> μs
t <sub>PLH</sub>	<u> </u>		$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$	lions	Min			μs
tpLH tPHL	Propagation Delay LOW		$R_L = 3 k\Omega$	lions	Min	0.7	4.0	
t <sub>PLH</sub>	Propagation Delay LOW Propagation Delay HIGH		$R_L = 3 k\Omega$ $C_L = 50 pF$		4.0	0.7	4.0	μs μs
tPLH tPHL tSK	Propagation Delay LOW Propagation Delay HIGH Skew  tpLH-tpHL		$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ ( <i>Figures 1</i> and 2)	CL = 50 pF		0.7 0.6 0.1	4.0 4.0 1.0	μs μs μs
tPLH tPHL tSK SR1 SR2	Propagation Delay LOW Propagation Delay HIGH Skew  t <sub>PLH</sub> -t <sub>PHL</sub>   Output Slew Rate		$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ ( <i>Figures 1</i> and 2) $R_{L} = 3 k\Omega \text{ to } 7 k\Omega,$	CL = 50 pF	4.0	0.7 0.6 0.1 15	4.0 4.0 1.0	μs μs μs V/μs
tPLH tPHL tSK SR1 SR2	Propagation Delay LOW Propagation Delay HIGH Skew  tpLH-tpHL  Output Slew Rate Output Slew Rate	I to LOW	$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ ( <i>Figures 1</i> and 2) $R_{L} = 3 k\Omega \text{ to } 7 k\Omega$ $R_{L} = 3 k\Omega, C_{L} = 2$	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15	4.0 4.0 1.0	μs μs μs V/μs
tPLH tPHL tSK SR1 SR2 RECEIVER	Propagation Delay LOW Propagation Delay HIGH Skew  t <sub>PLH</sub> -t <sub>PHL</sub>   Output Slew Rate Output Slew Rate	to HIGH	$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ ( <i>Figures 1</i> and 2) $R_{L} = 3 k\Omega \text{ to } 7 k\Omega,$	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15 5.0	4.0 4.0 1.0 30	μs μs μs V/μs V/μs
tPLH tPHL tSK SR1 SR2 RECEIVER tPLH	Propagation Delay LOW         Propagation Delay HIGH         Skew  tPLH-tPHL          Output Slew Rate         Output Slew Rate         RCHARACTERISTICS         Propagation Delay LOW	to HIGH	$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ ( <i>Figures 1</i> and 2) $R_{L} = 3 k\Omega \text{ to } 7 k\Omega$ $R_{L} = 3 k\Omega, C_{L} = 2$ Input Pulse Width >	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15 5.0 2.0	4.0 4.0 1.0 30 6.5	μs μs μs V/μs V/μs μs
tpLH tpHL tsK SR1 SR2 RECEIVER tpLH tpHL	Propagation Delay LOW         Propagation Delay HIGH         Skew  tpLH-tpHL          Output Slew Rate         Output Slew Rate         RCHARACTERISTICS         Propagation Delay LOW         Propagation Delay HIGH	to HIGH	$\begin{aligned} R_{L} &= 3 \ k\Omega \\ C_{L} &= 50 \ pF \\ (\textit{Figures 1} \ \text{and 2}) \\ \hline R_{L} &= 3 \ k\Omega \ \text{to 7} \ k\Omega, \\ R_{L} &= 3 \ k\Omega, \ C_{L} &= 2 \\ \hline Input Pulse Width > \\ C_{L} &= 50 \ pF \end{aligned}$	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15 5.0 2.0 2.8	4.0 4.0 1.0 30 6.5 6.5	μs μs μs V/μs V/μs ν/μs μs
tplh tphL tsk SR1 SR2 RECEIVER tpLH tphL tsk	Propagation Delay LOW         Propagation Delay HIGH         Skew  tpLH-tpHL          Output Slew Rate         Output Slew Rate         RCHARACTERISTICS         Propagation Delay LOW         Propagation Delay HIGH	to HIGH	$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ (Figures 1 and 2) $R_{L} = 3 k\Omega \text{ to } 7 k\Omega,$ $R_{L} = 3 k\Omega, C_{L} = 2$ Input Pulse Width > $C_{L} = 50 pF$ (Figures 3 and 4)	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15 5.0 2.0 2.8 0.8	4.0 4.0 1.0 30 6.5 6.5 2.0	μs μs μs V/μs V/μs μs μs
tpLH tpHL tsK SR1 SR2 RECEIVER tpLH tpHL tsK tpLz	Propagation Delay LOW         Propagation Delay HIGH         Skew  tpLH-tpHL          Output Slew Rate         Output Slew Rate         RCHARACTERISTICS         Propagation Delay LOW         Propagation Delay HIGH	to HIGH	$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ (Figures 1 and 2) $R_{L} = 3 k\Omega \text{ to } 7 k\Omega,$ $R_{L} = 3 k\Omega, C_{L} = 2$ Input Pulse Width > $C_{L} = 50 pF$ (Figures 3 and 4)	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15 5.0 2.0 2.8 0.8 0.1	4.0 4.0 1.0 30 6.5 6.5 2.0 2.0	μs μs ν/μs V/μs ν/μs μs μs μs
tplH           tpHL           tsK           SR1           SR2           RECEIVER           tpLH           tpLH           tpLH           tpLH           tpLH           tpLH           tpLL           tsk           tpLZ	Propagation Delay LOW         Propagation Delay HIGH         Skew  tpLH-tpHL          Output Slew Rate         Output Slew Rate         RCHARACTERISTICS         Propagation Delay LOW         Propagation Delay HIGH	to HIGH	$R_{L} = 3 k\Omega$ $C_{L} = 50 pF$ $(Figures 1 and 2)$ $R_{L} = 3 k\Omega to 7 k\Omega,$ $R_{L} = 3 k\Omega, C_{L} = 2$ Input Pulse Width > $C_{L} = 50 pF$ $(Figures 3 and 4)$ $(Figures 5 and 7)$	CL = 50 pF 500 pF	4.0	0.7 0.6 0.1 15 5.0 2.0 2.8 0.8 0.1 0.6	4.0 4.0 1.0 30 6.5 6.5 6.5 2.0 2.0 2.0	μs μs ν/μs V/μs ν/μs μs μs μs μs μs

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

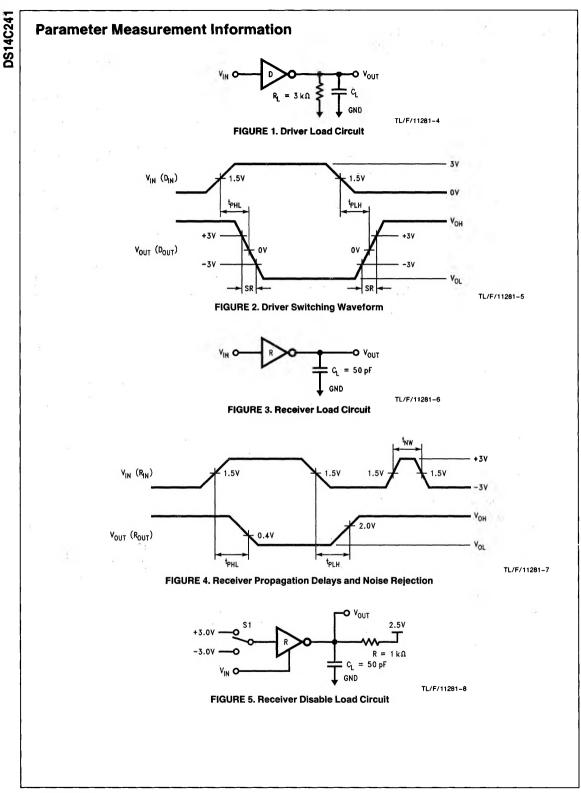
Note 2: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground unless otherwise specified.

Note 3:  $l_{OS}^+$  and  $l_{OS}^-$  values are for one output at a time. If more than one output is shorted simultaneously, the device power dissipation may be exceeded. Note 4: Receiver AC input waveform for test purposes:  $t_r = t_f = 200$  ns,  $V_{IL} = 3V$ ,  $V_{IL} = -3V$ , f = 64 kHz (128 kbits/sec). Driver AC input waveform for test purposes:  $t_r = t_f \le 10$  ns,  $V_{IL} = 3V$ ,  $V_{IL} = -3V$ , f = 64 kHz (128 kbits/sec). Driver AC input waveform for test purposes:  $t_r = t_f \le 10$  ns,  $V_{IL} = 3V$ , f = 64 kHz (128 kbits/sec).

Note 5: All typicals are given for V<sub>CC</sub> = 5.0V and T<sub>A</sub> =  $+25^{\circ}$ C.

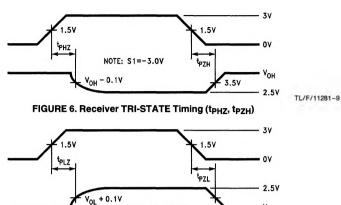
**Electrical Characteristics** (Continued)

Note 6: Ratings apply to ambient temperature at +25°C. Above this temperature derate: WM package 14.3 mW/°C.



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#### Parameter Measurement Information (Continued)



NOTE: \$1=+3.0V

FIGURE 7. Receiver TRI-STATE Timing (tpLZ, tpZL)

### Pin Descriptions

V<sub>CC</sub> (pin 11)—Power supply pin for the device,  $+5V (\pm 10\%)$ .

V<sup>+</sup> (pin 13)—Positive supply for TIA/EIA-232-E drivers. Recommended external capacitor: C4 = 1.0  $\mu$ F (6.3V). This supply is not intended to be loaded externally.

V<sup>-</sup> (pin 17)—Negative supply for TIA/EIA-232-E drivers. Recommended external capacitor: C3 = 1.0  $\mu$ F (16V). This supply is not intended to be loaded externally.

C1<sup>+</sup>, C1<sup>-</sup> (pins 12 and 14)—External capacitor connection pins. Recommended capacitor—1.0  $\mu$ F (6.3V).

C2<sup>+</sup>, C2<sup>-</sup> (pins 15 and 16)—External capacitor connection pins. Recommended capacitor—1.0  $\mu$ F (16V).

**EN (pin 24)**—Controls the Receiver output TRI-STATE Circuit. A HIGH level on this pin will disable the Receiver Output.

SHUTDOWN (SD) (pin 25)—A High on the SHUTDOWN pin will lower the total I<sub>CC</sub> current to less than 10  $\mu$ A. Providing a low power state.

 $D_{IN}$  1-4 (pins 7, 6, 20 and 21)—Driver input pins are TTL/ CMOS compatible. Inputs of unused drivers may be left open, an internal pull-up resistor (500 k $\Omega$  minimum, typically 5 M $\Omega$ ) pulls input to V<sub>CC</sub>. Output will be LOW for open inputs.

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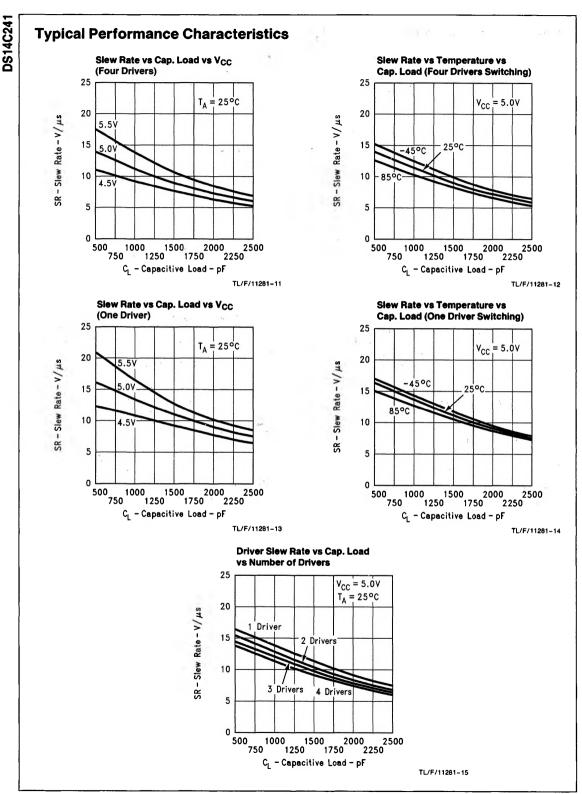
VOL

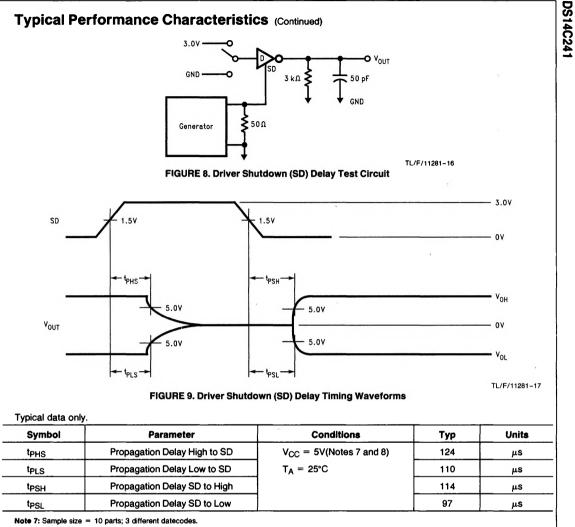
Dout 1-4 (pins 2, 3, 1 and 28)—Driver output pins conform to TIA/EIA-232-E levels.

 $R_{IN}$  1-5 (pins 9, 4, 27, 23 and 18)—Receiver input pins accept TIA/EIA-232-E input voltages (±15V). Receivers feature a noise filter and guaranteed hysteresis of 200 mV. Unused receiver input pins may be left open. Internal input resistor (5 kΩ) pulls input LOW, providing a failsafe HIGH output.

**R<sub>OUT</sub> 1-5 (pins 8, 5, 26, 22 and 19)**—Receiver output pins are TTL/CMOS compatible. Receiver output HIGH voltage is specified for both CMOS and TTL load conditions.

GND (pin 10)—Ground pin.





Note 8: All drivers are loaded as shown in Figure 8.